

UP PoE V2 Expansion Board

Maker Board UP-POEV2-30W

User's Manual 1st Ed

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Acknowledgement

UP POE V2 Expansion Bo

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Packing List

Before setting up your product, please make sure the following items have been shipped:

ltem		Quantity
•	UP POEV2 Carrier Board	1
•	FPC Cable	1
•	Power Cable	1
	(DC Jack 5.5x2.1mm to 3.96mm 1*2P housing.200mm)	
•	Screw/Stud Pack	1

If any of these items are missing or damaged, please contact your distributor or sales representative immediately.

About this Document

This User's Manual contains all the essential information, such as detailed descriptions and explanations on the product's hardware and software features (if any), its specifications, dimensions, jumper/connector settings/definitions, and driver installation instructions (if any), to facilitate users in setting up their product.

Users may refer to the product page at AAEON.com for the latest version of this document.

Safety Precautions

Please read the following safety instructions carefully. It is advised that you keep this manual for future references

- 1. All cautions and warnings on the device should be noted.
- 2. Make sure the power source matches the power rating of the device.
- Position the power cord so that people cannot step on it. Do not place anything over the power cord.
- Always completely disconnect the power before working on the system's hardware.
- 5. No connections should be made when the system is powered as a sudden rush of power may damage sensitive electronic components.
- If the device is not to be used for a long time, disconnect it from the power supply to avoid damage by transient over-voltage.
- 7. Always disconnect this device from any AC supply before cleaning.
- 8. While cleaning, use a damp cloth instead of liquid or spray detergents.
- 9. Make sure the device is installed near a power outlet and is easily accessible.
- 10. Keep this device away from humidity.
- 11. Place the device on a solid surface during installation to prevent falls
- 12. Do not cover the openings on the device to ensure optimal heat dissipation.
- 13. Watch out for high temperatures when the system is running.
- 14. Do not touch the heat sink or heat spreader when the system is running
- 15. Never pour any liquid into the openings. This could cause fire or electric shock.
- As most electronic components are sensitive to static electrical charge, be sure to ground yourself to prevent static charge when installing the internal components. Use a grounding wrist strap and contain all electronic components in any static-shielded containers.

- 17. If any of the following situations arises, please the contact our service personnel:
 - i. Damaged power cord or plug
 - ii. Liquid intrusion to the device
 - iii. Exposure to moisture
 - iv. Device is not working as expected or in a manner as described in this manual
 - v. The device is dropped or damaged
 - vi. Any obvious signs of damage displayed on the device

DO NOT LEAVE THIS DEVICE IN AN UNCONTROLLED ENVIRONMENT WITH TEMPERATURES BEYOND THE DEVICE'S PERMITTED STORAGE TEMPERATURES (SEE CHAPTER 1) TO PREVENT DAMAGE.

FCC Statement



This device complies with Part 15 FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received including interference that may cause undesired operation.

Caution:

There is a danger of explosion if the battery is incorrectly replaced. Replace only with the same or equivalent type recommended by the manufacturer. Dispose of used batteries according to the manufacturer's instructions and your local government's recycling or disposal directives.

Attention:

Il y a un risque d'explosion si la batterie est remplacée de façon incorrecte. Ne la remplacer qu'avec le même modèle ou équivalent recommandé par le constructeur. Recycler les batteries usées en accord avec les instructions du fabricant et les directives gouvernementales de recyclage.

China RoHS Requirements (CN)

产品中有毒有害物质或元素名称及含量

AAEON Main Board/ Daughter Board/ Backplane

	有毒有害物质或元素					
部件名称	铅	汞	镉	六价铬	多溴联苯	多溴二苯醚
	(Pb)	(Hg)	(Cd)	(Cr(VI))	(PBB)	(PBDE)
印刷电路板	x	x	0	0	0	0
及其电子组件	X	X	0	0	0	0
外部信号	x	v	0	0	0	0
连接器及线材	X	X	0	0	0	0
O:表示该有毒有害物质在该部件所有均质材料中的含量均在 SJ/T 11363-2006标准规定的限量要求以下。						
X:表示该有毒有害物质至少在该部件的某一均质材料中的含量超出 SJ/T 11363-2006 标准规定的限量要求。						
备注:此产品所标示:	备注:此产品所标示之环保使用期限,系指在一般正常使用状况下。					

Carrier Board

China RoHS Requirement (EN)

Poisonous or Hazardous Substances or Elements in Products AAEON Main Board/ Daughter Board/ Backplane

	Poisonous or Hazardous Substances or Elements					
Component	Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Hexavalent Chromium (Cr(VI))	Polybrominated Biphenyls (PBB)	Polybrominated Diphenyl Ethers (PBDE)
PCB & Other Components	Х	Х	0	0	0	0
Wires & Connectors for External Connections	Х	Х	0	0	0	0

O: The quantity of poisonous or hazardous substances or elements found in each of the component's parts is below the SJ/T 11363-2006-stipulated requirement.

X: The quantity of poisonous or hazardous substances or elements found in at least one of the component's parts is beyond the SJ/T 11363-2006-stipulated requirement.

Note: The Environment Friendly Use Period as labeled on this product is applicable under normal usage only

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Chapter 1

Product Specifications

1.1 Specifications

System	
PoE Spec	POE+ (IEEE 802.3at Type 2)
Ethernet	10/100/1000GbE Base
External Ports	RJ-45 x 1
	USB 3.2 Gen 1 x 1
Internal Connector	41-pin FPC Connector x 1
	10-pin Wafer x 1
Dimension	3.37" x 2.22" (85mm x 56mm)
Net Weight	0.09 lb. (0.042Kg)
Gross Weight	0.13 lb. (0.06Kg)
Operating Temperature	32°F ~ 140°F (0°C ~ 60°C) 0.5m/s airflow
Operating Humidity	10% ~ 80% relative humidity, non-condensing

Chapter 2

Hardware Information

2.1 Dimensions



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2.2 Board Layout



2.3 List of Jumpers and Connectors

Label	Functional Description
CN1	FPC/FFC Connector
CN3	USB/UART Wafer
CN6	Power Output (12V)
CN7	PoE LAN Port
CN8	USB 3.2 Gen 1 Port
CN10	Fan Connector (Optional)



Pin	Signal Description	Pin	Signal Description
1	GND	2	NC
3	NC	4	GND
5	USB3 RX_N	6	USB3 RX_P
7	GND	8	USB3 TX_N
9	USB3 TX_P	10	GND
11	NC	12	USB2 DN
13	USB2 DP	14	PCIE Clock_N
15	PCIE Clock_P	16	GND
17	PCIE_RXP	18	PCIE_RXN
19	GND	20	PCIE_TXN
21	PCIE_TXP	22	GND
23	PCIe Wake(1.8V)	24	Suspend clock
25	NC	26	NC
27	NC	28	Platform reset
29	Sleep S3(3.3V)	30	Sleep S0(3.3V)
31	GND	32	+1.8V
33	+1.8V	34	NC
35	NC	36	NC
37	NC	38	NC

Pin	Signal Description	Pin	Signal Description
39	NC	40	NC
41	GND	H1	GND
H2	GND	-	-

2.3.2 USB/UART Wafer (CN3)



Pin	Signal Description	Pin	Signal Description
1	+5V	2	USB2_DN
3	USB2_DP	4	GND
5	+5V	6	NC
7	NC	8	GND
9	NC	10	NC
H1	GND	H2	GND

2.3.3 Power Output (12V) (CN6)

Pin	Signal Description	Pin	Signal Description
1	+12V(Output)	2	GND

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2.3.4 PoE LAN Port (CN7)



Pin	Signal Description	Pin	Signal Description
1	LAN_TMDI0+	2	LAN_TMDI0-
3	LAN_TMDI1+	4	LAN_TMDI2+
5	LAN_TMDI2-	6	LAN_TMDI1-
7	LAN_TMDI3+	8	LAN_TMDI3-
9	LAN LED Active+	10	LAN LED Active-
11	LAN Link 1000#	12	LAN Link 100#
H1	NC	H2	NC
H3	Chassis GND	H4	Chassis GND



Pin	Signal Description	Pin	Signal Description
1	+5V	2	USB2_DN
3	USB2_DP	4	GND
5	USB3_RXN	6	USB3_RXP
7	GND	8	USB3_TXN
9	USB3_TXP	-	-
H1	GND	H2	GND

2.3.6 Fan Connector (Optional) (CN10)

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Pin	Signal Description	Pin	Signal Description
1	+12V	2	GND

Chapter 3

Carrier Board Installation

3.1 Installation Guide

For this process you will need a Phillips head screwdriver.

Step 1: Remove the four (4) screws on the board.







Step 2: Lock the four pillars and make sure to unlock the UP 4000's FPC connector.



Step 3: Plug the FPC cable into the FPC connector, noting the direction of the FPC cable via the printing on its top side, as shown.



Step 4: Align the PoE 30W module with the stud hole, and lock it with the four (4) screws that were removed in step 1. Then, wrap the FPC cable up and insert it into the unlocked FPC connector on the POE module.



Step 5: Plug the power cable into the power jack and plug the other side into the PoE module's wafer.



Appendix A

Connectors

A.1 Connectors

This table provides detailed information about the cables and connectors used by the UP POE V2 Expansion Board (UP-POEV2-30W-A10-0001). If you have any questions about the configuration of your board, please contact your AAEON sales representative.

Label	Description	Connector Type	
CN1	FPC/FFC	(TF)FPC/FFC Conn.41P.90D(F).SMD.0.6mm.Hirose. FH35C-41S-0.3SHW(50)	
СN3	USB/UART Wafer	(TF)Wafer.SMD.Pitch=1.0mm.10P.90D.MALE.BOX NON LOCK.PINREX.710-74-10TWRG.NY9T	
CN6	Power Output (12V)	(TF)WAFER.2P.180D(M).3.96mm.W/LOCK.HO- BASE.3962-WS-2	
CN7	POE LAN	(TF)RJ45.12P.90D(F).W/LED(L-Y,R-G/O).W/O Transformer.W/ Spring (TOP).DIPLZ.R31-C118420-3151	
CN8	USB 3.2 Gen 1	(TF)USB3.0 Connector.Single Port.Type A. 9P.90D(F).SMD.Trontek.930-00406-A91-22	
CN10	FAN Conn (Optional)	(TF)Wafer.SMD.Pitch=1.25mm.2P.180D.MALE .BOXNON LOCK.PINREX.712-P91-025WEH.(PIP)	